Overview

HP ProBook 645 G4



Right

- 1. Webcam (Select models)
- 2. Webcam LED (Select models)
- 3. Internal microphones (2)
- 4. Power connector
- 5. MicroSD card slot
- 6. Docking connector
- 7. VGA port
- 8. Ethernet port

- 9. HDMI port (Cable not included)
- **10.** USB 3.1 Gen 1 port
- 11. USB 3.1 Gen 1 charging port
- **12.** USB Type-C[™] charging port
- 13. HDD LED indicator
- 14. Fingerprint reader (Select models)
- 15. Clickpad

Overview



Left

- 1. Smart Card Reader (Select models)
- 2. Audio combo jack
- 3. USB 3.1 Gen 1 port

- 4. Security lock slot (Lock sold separately)
- 5. Power button

Overview

AT A GLANCE

- Windows 10 versions or FreeDOS 2.0
- · Precision-crafted slim design with fingerprint resistant modern, fresh and comfortable natural silver finish
- Efficiently powerful, highly secure, and reliable AMD Ryzen™ PRO processor with Radeon™ Vega graphics designed for a highly responsive experience that helps secure your data, device, and identity
- HP Premium keyboard, spill resistant with optional backlit design
- Large Clickpad with gestures support
- Enhanced security features including TPM2.0, HP Privacy Camera, optional Smart Card Reader, optional Finger Print Reader, and HP Sure Start Gen4.
- LED-backlit display
 - 35.56 cm (14") diagonal HD and FHD or Touch FHD with camera and with WWAN
- HDMI port for connecting to high-resolution displays
- Optional HD webcam with dual-microphone array for video conferencing
- Three USB 3.1 Gen1 ports (1 charging) and one USB-C port (PD+DP, Gen1)
- Flexible wireless connectivity options
- Battery life up to 10 hours 15 minutes with fast charging technology
- Dual storage combines SSD fast boot up and app access with cost effective HDD mass storage
- Passed MIL-STD 810G testing¹
- Compliance with FCC (Class B)

1. MIL-STD-810G testing is conducted on select HP products. Testing is not intended to demonstrate fitness of U.S. Department of Defense (DoD) contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.

NOTE: See important legal disclosures for all listed specs in their respective features sections.



PRODUCT NAME

HP ProBook 645 G4

OPERATING SYSTEM

Preinstalled Windows 10 Pro 64¹

Windows 10 Home 64 (National Academic only)1,2

Windows 10 Home 641

Windows 10 Home Single Language 641

FreeDOS 2.0

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com/.

2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

PROCESSORS

AMD Ryzen™ 3 PRO 2300U Mobile Processor with Radeon™ Vega Graphics (2 GHz base frequency, up to 3.4 GHz, 6 MB cache, 4 cores)³,⁴
AMD Ryzen™ 5 PRO 2500U Mobile Processor with Radeon™ Vega Graphics (2 GHz base frequency, up to 3.6 GHz, 6 MB cache, 4 cores)³,⁴
AMD Ryzen™ 7 PRO 2700U Mobile Processor with Radeon™ Vega Graphics (2.2 GHz base frequency, up to 3.8 GHz, 6 MB cache, 4 cores)³,⁴

Processor Family

AMD Ryzen™ 3 PRO APU processor AMD Ryzen™ 5 PRO APU processor AMD Ryzen™ 7 PRO APU processor

- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering, branding and/or naming is not a measurement of higher performance.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

CHIPSET

Chipset is integrated with processor



Technical Specifications

GRAPHICS

Integrated

AMD Radeon™ Vega Graphics

DISPLAY

Non-Touch HD

35.56 cm (14") diagonal HD SVA eDP anti-glare LED-backlit, 220 cd/m², 45% NTSC, (1366 x 768)^{5,6}

35.56 cm (14") diagonal HD SVA eDP anti-glare LED-backlit, 220 cd/m², 45% NTSC, (1366 x 768) for camera^{5,6}

35.56 cm (14") diagonal HD SVA eDP anti-glare LED-backlit, 220 cd/m², 45% NTSC, (1366 x 768) for WWAN^{5,6}

35.56 cm (14") diagonal HD SVA eDP anti-glare LED-backlit, 220 cd/m², 45% NTSC, (1366 x 768) for camera and for WWAN^{5,6}

Non-Touch FHD

35.56 cm (14") diagonal FHD IPS eDP anti-glare LED-backlit, 220 cd/m², 45% NTSC, (1920 x 1080) $^{5.6}$ 35.56 cm (14") diagonal FHD IPS eDP anti-glare LED-backlit, 220 cd/m², 45% NTSC, (1920 x 1080) for camera $^{5.6}$ 35.56 cm (14") diagonal FHD IPS eDP anti-glare LED-backlit, 220 cd/m², 45% NTSC, (1920 x 1080) for WWAN $^{5.6}$ 35.56 cm (14") diagonal FHD IPS eDP anti-glare LED-backlit, 220 cd/m², 45% NTSC, (1920 x 1080) for camera and for WWAN $^{5.6}$

Touch FHD

35.56 cm (14") diagonal FHD IPS eDP LED-backlit touch screen 220 cd/m², 45% NTSC, (1920 x 1080) for camera and for WWAN^{5,6}

- 5. HD content required to view HD images.
- 6. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

Docking station model	Total number of supported displays (incl. the notebook display)	Max. resolutions supported	Dock Connectors	Technical limitations
HP UltraSlim Docking Station	3	Dual 2.5K @ 60Hz	2xDP, 1xVGA	Dual 2.5k only with both displays into DP
HP Thunderbolt Dock G2	3	Single 4K@60Hz (3840 x 2160)	2xDP, 1xVGA, 1xTB,1xUSB-C alt-mode	System will perform at USB 3.0 Gen1 speeds when connected to the dock (5Gbits) Thunderbolt port will function as a USB 2.0 port with data and power out (15W) only.
HP USB-C Dock G4	3	Dual 2K @ 60Hz Single 4K @ 60Hz (3840 x 1440)	1xHDMI, 2xDP	
HP USB-C Universal Dock	3	Dual 4K @ 60Hz Single 5K @ 60Hz	2xDP	
HP USB-C Travel Dock	2	Single 2K @ 60Hz	1xHDMI, 1xVGA	Single external display Only HDMI or VGA at the time
HP USB-C Mini Dock	2	Single 4K @ 30Hz	1xHDMI, 1xVGA	Single external display Only HDMI or VGA at the time



STORAGE AND DRIVES

Primary Storage

500 GB 7200 rpm⁷
500 GB 7200 rpm Self Encrypting Drive (FIPS-140-2)⁷
1 TB 7200 rpm⁷

Primary M.2 Storage

128 GB SATA-3 SS TLC⁷
256 GB SATA-3 TLC OPAL2⁷
256 GB PCIe NVMe SS Value⁷
256 GB PCIe Gen3x4 NVMe SS TLC⁷
512 GB SATA SS TLC (FIPS)⁷
512 GB PCIe Gen3x4 NVMe SS TLC⁷
1 TB PCIe Gen3x4 NVMe SS TLC⁷

7. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

MEMORY

Maximum Memory

32 GB DDR4-2400 SDRAM8

Memory

4 GB Total System Memory (4 GB x 1)⁸
8 GB Total System Memory (4 GB x 2)⁸
8 GB Total System Memory (8 GB x 1)⁸
12 GB Total System Memory (8 GB + 4 GB)⁸
16 GB Total System Memory (16 GB x 1)⁸
16 GB Total System Memory (8 GB x 2)⁸
32 GB Total System Memory (16 GB x2)⁸

Memory Slots

2 SODIMM
Both slots are customer accessible / upgradeable
DDR4 PC4 SODIMMS - System supports run rate at 2400
Supports Dual Channel Memory

8. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.



NETWORKING/COMMUNICATIONS

WI AN

Intel® Dual Band Wireless-AC 3168 802.11a/b/g/n/ac (1x1) Wi-Fi® and Bluetooth® 4.2 Combo, non-vPro™9 Intel® Dual Band Wireless-AC 8265 802.11a/b/g/n/ac (2x2) Wi-Fi® and Bluetooth® 4.2 Combo, non-vPro™9 Realtek 802.11ac (2x2) Wi-Fi® and Bluetooth® 4.2 Combo® Realtek 802.11ac (1x1) Wi-Fi® and Bluetooth® 4.2 Combo®

WWAN

LTE CAT4: Huawei HP lt4132, LTE/HSPA+ w/GPS M.2¹⁰ LTE CAT9: Fibocom Intel(R) XMM(TM) 7360 LTE-Advanced lt4210 LTE/HSPA+ w/GPS¹⁰

NFC

NXP NPC300 Near Field Communication Module¹¹

WPAN Bluetooth

Bluetooth® 4.2 supported via all supported WLAN modules9

Ethernet

Realtek RTL8111EPH-CG 10/100/1000 Ethernet NIC with DASH Support¹²

- 9. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

 10. WWAN module requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.
- 11. Sold separately or as an optional feature.
- 12. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers Integrated dual array microphone

Webcam

720p HD HP Privacy Camera^{5,11,13}

- 5. HD content required to view HD images.
- 11. Sold separately or as an optional feature.
- 13. Internet access required.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Advanced Keyboard ClickPad, Spill-resistant with drain ClickPad, Spill-resistant with drain, DuraKeys & Backlit Dual Point, Spill-resistant with drain, DuraKeys & Backlit

Function Keys

ESC: system information

F1 - Display Switching

F2 - Blank or Privacy

F3 - Brightness Down

F4 - Brightness Up

F5 - Speaker Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Backlight Toggle (for backlit keyboard) or Blank

F10 - NumLock

F11 - Wifi Toggle

F12 – Sleep

Clickpad requirements:

On/off control by driver

Taps enabled as default

Gestures:

(Win 10):

Disabled by default:

3 Finger Flick

2 Finger Rotate

Momentum Motion

1 Finger Vertical Scroll

Win 10:

Support PTP with Miniport driver

Settings enabled by default by MSFT:

2 Finger Scrolling

2 Finger Zoom (Pinch)

OSD (enable/disable)

3 finger tap - Cortana

3 finger flick -App switch

4 finger tap - Action Center



SOFTWARE AND SECURITY

Preinstalled Software BIOS

HP BIOSphere Gen4¹⁷

HP DriveLock & Automatic DriveLock

BIOS Update via Network

Master Boot Record Security

Power On Authentication

Secure Erase¹⁸

Absolute Persistence Module¹⁹

Pre-boot Authentication

HP Wireless Wakeup

Software

HP Native Miracast Support¹⁵

HP LAN-Wireless Protection

HP Velocity

HP 3D DriveGuard

HP ePrint + JetAdvantage²⁰

HP Hotkey Support - CMIT

HP Recovery Manager

HP Jumpstart

HP Support Assistant²¹

HP Noise Cancellation Software

HP Host Based MAC Address Manager

Buy Office

Manageability Features

HP Driver Packs²²

HP System Software Manager (SSM)

HP BIOS Config Utility (BCU)

HP Client Catalog

HP Manageability Integration Kit Gen2²³

Ivanti Management Suite



Technical Specifications

Client Security Software

HP Client Security Suite Gen4 including:25

HP Security Manager²⁶ (including Credential Manager, HP Password Manager, HP Spare Key)

Power On Authentication

HP Fingerprint Sensor²⁸

HP Device Access Manager

Microsoft Defender²⁷

Security Management

Secure Erase¹⁸

TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)

SATA 0,1 port disablement (viaBIOS)

RAID configurations²⁹

Serial, USB enable/disable (viaBIOS)

Power-on password (viaBIOS)

Setup password (viaBIOS)

Support for chassis padlocks and cable lock devices

Integrated hood sensor

HP Sure Click³⁰

Security

TPM

Model: TPM SLB9670 VQ2.0 FW7.63RS3 913310-002

Version: TPM 2.0 Revision: 1.16

FIPS 140-2 Compliant: No

Smartcard Reader

Model number: Alcor AU9560 FIPS 201 Compliant: Yes

IPv6 Certification

No

MD5 Hash

Please follow the instructions below to access MD5 Hash.

Log-on to http://hp.com/support, enter your product name, select software and drivers, select OS, select driver. After selecting the driver, click on "Associated files" and then click on "Download". When opening the file, under "Purpose" you should see the appropriate "SOFTPAQ MD5:" Field



Technical Specifications

Is the BIOS on this notebook ISO/IEC 19678:2015 (formerly NIST 800-147) compliant?:

Yes

UEFI version: 2.5

16. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming 17. HP BIOSphere Gen4 features may vary depending on the PC platform and configurations. Requires Intel® or AMD 8th generation processors.

18. Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88. Supported on Elite platforms with BIOS version F.03 or higher.

19. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

20. HP ePrint Driver requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see http://www.hp.com/go/eprintcenter). Print times and connection speeds may vary.

- 21. HP Support Assistant requires Windows and Internet access.
- 22. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- 23. HP Manageability Integration Kit can be downloaded from

http://www8.hp.com/us/en/ads/clientmanagement/overview.html

- 24. Ivanti Management Suite subscription required.
- 25. HP Client Security Suite Gen 4 requires Windows and Intel® or AMD 8th generation processors.
- 26. HP Password Manager requires Internet Explorer or Chrome or FireFox. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.
- 27. Microsoft Defender Opt in and internet connection required for updates.
- 28. HP Fingerprint Sensor sold separately or as an optional feature.
- 29. RAID configuration is optional and does require a second hard drive.
- 30. HP Sure Click is available on select HP platforms and supports Microsoft® Internet Explorer and Chromium™. Check http://h20195.www2.hp.com/v2/GetDocument.aspx?docname=4AA7-0922ENW for all compatible platforms as they become available.



Technical Specifications

POWER

Power Supply

HP Smart 45 W right angle 4.5 mm AC Adapter³¹
HP Smart 65 W right angle 4.5 mm AC Adapter³¹
HP Smart 45 W right angle 4.5 mm AC Adapter 2-prong (Japan only)³¹
45 W USB Type-C[™] adapter³¹
65 W USB Type-C[™] adapter³¹

Primary Battery

HP Long Life 3-cell, 48 Wh Li-ion³² HP Fast Charge Technology - 90% in 90minutes

Power Cord

3-wire plug (C5), 1.8m, Sticker, Conventional³¹
3-wire plug (C5), 1.0m, Sticker, Conventional³¹
2-wire plug (C5), 1.0m, Sticker, Conventional (Japan only)³¹

Battery Life

Up to 10 hours 15 minutess (with SSD)33

- 31. Availability may vary by country.
- 32. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 33. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details.

WEIGHTS & DIMENSIONS

Weight

Starting at 3.8 lb (non-touch); Starting at 4.26 lb (touch)³⁴ Starting at 1.73 kg (non-touch); Starting at 1.93 kg (touch)³⁴

Dimensions (W x D x H)

Non-touch

13.4 x 9.5 x 0.83 in 34 x 24 x 2.095 cm

Touch

13.4 x 9.5 x 0.87 in 34 x 24 x 2.195 cm

34. Weight will vary by configuration.

Technical Specifications

PORTS/SLOTS

Ports

1 USB 3.1 Type-C™ (Power delivery, DisplayPort 1.4) 1 USB 3.1 Gen 1 (charging) 2 USB 3.1 Gen 1 1 HDMI 1.4³⁵ 1 RJ-45 1 VGA 1 headphone/microphone combo 1 AC power

Expansion Slots

1 docking connector1 microSD (multi-format digital media reader)35. HDMI cable sold separately.

SERVICE AND SUPPORT

HP Services offers 3 year and 1 year limited warranties and 90 day support options depending on country. Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc³⁶

36. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



Technical Specifications

ENVIRONMENTAL & INDUSTRY

	IIAL & INDUSTRI	_				
Environmental			•		g certified to the following	
Data	approvals and may be labeled with one or more of these marks:					
	Eco-Label Certifications & declarations	 IT ECO declaration US ENERGY STAR® EPEAT® Silver registered in the United States. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit http://www.epeat.net for more information. 				
	System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".				
	Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC	c, 50Hz	100VAC, 60Hz	
	Normal Operation (Short idle)	9.76 W	9.19	e W	9.22 W	
	Normal Operation (Long idle)	6.55 W	7.66	5 W	6.72 W	
	Sleep	0.91 W	0.95	5 W	0.92 W	
	Off	0.52 W	0.53	3 W	0.54 W	
		NOTE: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.				
	Heat Dissipation*	115VAC, 60Hz	230VAC	., 50Hz	100VAC, 60Hz	
	Normal Operation (Short idle)	33 BTU/hr	31 BT	U/hr	32 BTU/hr	
	Normal Operation (Long idle)	22 BTU/hr	26 BT	U/hr	23 BTU/hr	
	Sleep	3 BTU/hr	3 BTI	U/hr	3 BTU/hr	
	Off	2 BTU/hr	2 BTI	U/hr	2 BTU/hr	
		NOTE: Heat dissipation is service level is attained fo		ed on the mea	sured watts, assuming the	
	Declared Noise Emissions	Sound Power (L _{WAd} , bels)		Sound Pressure (L _{pAm} , decibels)		



Technical Specifications

(in accordance with ISO 7779 and ISO 9296)					
Typically Configured – Idle		3	22		
Fixed Disk – Random writes		3.9	34		
Longevity and Upgrading			xtending its useful life by seve ponents contained in the proc		
	Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.				
Batteries	This battery(s) in this product comply with EU Directive 2006/66/EC				
	Mercury grea Cadmium gre Battery size: Battery type:	ed in the product do not cont ter the1ppm by weight eater than 20ppm by weight CR2032 (coin cell) Lithium CR2032 (coin cell)	ain:		
	Battery type:				
Additional Information	 This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC. This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). This product is in compliance with the IEEE 1680.1 (EPEAT) standard at the Silver level, see http://www.epeat.net Plastics parts weighing over 25 grams used in the product are marked per IS011469 and IS01043. This product contains 0% post-consumer recycled plastic (by wt.) This product is 94.4% recycle-able when properly disposed of at end of life. 			al and tate of 1986). Indard at marked wt.)	
Packaging Materials	External:	PAPER/Corrugated		225 g	
		PAPER/Paper		40 g	
	PLASTIC/Polyethylene low density – LDPE 7 The plastic packaging material contains at least 50% recycled content. The corrugated paper packaging materials contains at least 75% recycled				
Material Usage	content. This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):				
		estos ain Azo Colorants			



Technical Specifications

		Products returned to HP will be recycled, recovered or disposed of in a responsible manner. The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers . These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers
	End-of-life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office.
	Packaging Usage	retardants in plastics Cadmium Chlorinated Hydrocarbons Chlorinated Paraffins Formaldehyde Halogenated Diphenyl Methanes Lead carbonates and sulfates Lead and Lead compounds Mercuric Oxide Batteries Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. Ozone Depleting Substances Polybrominated Biphenyls (PBBs) Polybrominated Biphenyl Ethers (PBBEs) Polybrominated Biphenyl Oxides (PBBOs) Polychlorinated Biphenyl (PCB) Polychlorinated Terphenyls (PCT) Polyvinyl Chloride (PVC) — except for wires and cables, has been voluntarily removed from most applications. Radioactive Substances Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO) HP follows these guidelines to decrease the environmental impact of product packaging: Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Eliminate the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
_		Certain Brominated Flame Retardants – may not be used as flame retardants in plastics

who integrate and re-sell HP equipment.

Technical Specifications

HP, Inc. Corporate	For more information about HP's commitment to the environment:		
Environmental Information	Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates:		
	http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf		

SERVICE AND SUPPORT

HP Services offers a 1-year limited warranties and 90 day support options depending on country. Batteries have a default one year limited warranty. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.³⁷

37 . HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

Technical Specifications

DISPLAYS

14" diagonal FHD UWVA antiglare flat LED backlit nontouch; 220 cd/m²; 45% sRGB (1920 x 1080) Outline Dimensions (W x H) 320.9x205.6 (max)

Active Area 309.31 x 173.99

Weight 290 max.

Diagonal Size 14 (inch)

Thickness 3.0mm max

Interface eDP 1.2

Surface Treatment Anti-Glare (AG)

Touch Enabled None

Contrast Ratio 600:1 (typ) - AG

Refresh Rate 60Hz

Brightness 220 nits

Pixel Resolution 1920 x 1080 (FHD)

Format of LCD Pixel Arrangement RGB

Backlight LED

Color Gamut Coverage45% of NTSCColor Depth6 bits + Hi FRC

Viewing Angle UWVA 85/85/85



Technical Specifications

14" diagonal FHD UWVA anti- Outline Dimensions (W x H) glare flat LED backlit touch; 220 cd/m²; 45% sRGB (1920 x 1080)

320.9x205.6 (max)

Active Area 309.31 x 173.99

Weight 290 max. **Diagonal Size** 14 (inch) **Thickness** 3.0mm max Interface eDP 1.2

Surface Treatment ΒV **Touch Enabled** Yes

Contrast Ratio 600:1 (typ) - AG

Refresh Rate 60Hz **Brightness** 220 nits

Pixel Resolution 1920 x 1080 (FHD)

Format LCD Pixel Arrangement RGB Backlight LED

Color Gamut Coverage 45% of NTSC **Color Depth** 6 bits + Hi FRC

Viewing Angle UWVA 85/85/85/85



Technical Specifications

14" diagonal HD SVA antiglare LED-backlit non-touch; 220 cd/m²; 45% sRGB (1366 x 768) Outline Dimensions (W x H) 320.9 x 205.6 (mm) max

Active Area 309.40 x 173.95 (mm)

Weight 290 g max

Diagonal Size 14 (inch)

Thickness 3.0 (mm) max

Interface eDP 1.2

Surface Treatment Anti-Glare (AG)

Touch Enabled None

Contrast Ratio 300:1 (typical)

Refresh Rate 60 Hz **Brightness** 220 nits

Pixel Resolution 1366 x 768 (HD)

Format of LCD Pixel Arrangement RGB

Backlight LED

Color Gamut Coverage45% of NTSCColor Depth6 bits + Hi FRCViewing AngleSVA 40/40/15/30

NOTE: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Technical Specifications

STORAGE

HDD 500 GB 7200RPM 7mm

SATA

Drive Weight 0.21 lb (95 g) **Rotation speed** 7200RPM **Cache Buffer** Up to 32MB Height 0.28 in (7 mm) Width 2.75 in (69.85 mm) Interface **ATA-8, SATA 3.0**

Transfer Rate 600 MB/s

Seek Time Single Track: 2 ~ 1.5 ms;

> Average: 11 ~ 13 ms; Maximum: 18 ~ 22 ms

Logical Blocks 976773168

Operating Temperature 32° to 140°F (0° to 60°C) [ambient temp]

0.21 lb (95 q)

Security Features ATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

HDD 500 GB 7200RPM 7mm FIPS SATA Opal2

Drive Weight Rotation speed Cache Buffer Height

7200 rpm Up to 32MB 0.28 in (7 mm) 2.75 in (69.85 mm) Width Interface **ATA-8, SATA 3.0 Transfer Rate** 600 MB/s

Seek Time Single Track: 2 ~ 1.5 ms; Average: 11 ~ 13 ms;

Maximum: 18 ~ 22 ms

Logical Blocks 976,773,168

Operating Temperature 32° to 140°F (0° to 60°C) [ambient temp]

Security Features ATA Security; TCG Opal 2.x, FIPS **Features** S.M.A.R.T., NCQ, Ultra DMA



Technical Specifications

HDD 1 TB 7200RPM 7mm SATA Drive Weight 90g

2.5in

Rotation speed7200rpmCache Buffer128MBHeight7.2mm Max.

Width 69.85mm

Interface ATA-8, SATA 3.0

Transfer Rate 600 MB/s

Seek Time Single Track: 1.5 ms;

Average: 13 ms; Maximum: 32 ms

Logical Blocks 1,953,525,168

Operating Temperature 0~60°C

Security Features ATA Security

Features S.M.A.R.T., NCQ, Ultra DMA, TRIM



Technical Specifications

SSD 128 GB 2280 M2 SATA-3

TLC

Drive Weight0.02 lb (10 g)Capacity128 GBNAND TypeTLC

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Interface ATA-8, SATA 3.0
Maximum Sequential Read Up To 520 MB/s
Maximum Sequential Write Up To 450 MB/s
Logical Blocks 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

SSD 256 GB 2280 M2 PCle-3x4 Drive Weight

SS NVMe TLC

Drive Weight0.02 lb (10 g)Capacity256 GBNAND TypeTLC

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Interface PCIe NVMe Gen3X4
Maximum Sequential Read Up To 2600 MB/s
Maximum Sequential Write Up To 900 MB/s
Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM; L1.2

SSD 256 GB 2280 M2 SATA-3 Self Encrypted OPAL2 TLC

Drive Weight0.02 lb (10 g)Capacity256 GBNAND TypeTLC

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Interface ATA-8, SATA 3.0
Maximum Sequential Read Up To 530 MB/s
Maximum Sequential Write Up To 515 MB/s
Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

Technical Specifications

256 GB 2280 PCIe NVMe Value Drive Weight Solid State Drive

Drive Weight0.02 lb (10 g)Capacity256 GBNAND TypeMLC

Height 0.09 in (2.3 mm)

Width 0.87 in (22 mm)

Interface PCIe NVMe Gen3X4

Maximum Sequential Read Up To 1700 MB/s

Maximum Sequential Write Up To 600 MB/s

Logical Blocks 703.282.608

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM; L1.2

SSD 512 GB 2280 M2 PCIe-3x4 Drive Weight SS NVMe TLC

Drive Weight0.02 lb (10 g)Capacity512 GBNAND TypeTLC

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Interface PCIe NVMe Gen3X4
Maximum Sequential Read Up To 2600 MB/s
Maximum Sequential Write Up To 1400 MB/s
Logical Blocks 1,000,215,216

Features TRIM; L1.2

Operating Temperature

SSD 512 GB 2280 M2 SATA-3 TLC FIPS Drive Weight0.02 lb (10 g)Capacity512GBNAND TypeTLC

Height 0.09 in (2.3 mm)
Width 0.87 in (22 mm)
Interface ACS-3, SATA 3.2
Maximum Sequential Read Up To 530 MB/s
Maximum Sequential Write Up To 400 MB/s
Logical Blocks 1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

Technical Specifications

SSD 1 TB 2280 PCIe-3x4 NVMe Drive Weight 0.02 lb (10 g)

TLC SS

Capacity1 TBNAND TypeTLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X4

Maximum Sequential Read2900Maximum Sequential Write2000

Logical Blocks 2,000,409,263

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM; L1.2



Technical Specifications

POWER

AC Adapter 65 Watt nPFC Dimensions USB Type C™ Weight

 Dimensions
 74x74x28.5mm

 Weight
 unit: 245g +/- 10g

Input Input Efficiency 81.5% min at 115 Vac/ 230Vac @ 5V/3A

86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 10V/5A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A

Input frequency range 47 ~ 63 Hz

Input AC current 1.7 A at 90 VAC and maximum load

Output Output power 65W

 DC output
 5V/9V/10V/12V/15V/20V

 Hold-up time
 5ms at 115 Vac input

Output current limit <8.0A

Connector Duck head / duck head power cord, without Smart ID DC connector

Environmental Design Operating temperature 32°Fto 95°F (0°to 35°C)
Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 5% to 95% **Storage Humidity** 5% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 100,000 hours at 25°C ambient condition.

Technical Specifications

AC Adapter 45 Watt nPFC USB Type C™

62.0x62.0x28.5mm

Weight unit: 220g +/- 10g

Input Input Efficiency

Input Efficiency Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:5V: 81.5%9V: 86.7%10V: 87.5%12V: 87.8%15V:

87.8%20V:87.8%

Input frequency range 47 ~ 63Hz

Input AC current Max. 1.4 A at 90 Vac

Output Output power 5V/15W

9V/27W 10V/37.5W 12V/45W 15V/45W 20V/45W

DC output 5V / 9V / 10V / 12V / 15V / 20V

Hold-up time 5ms at 115 Vac input

Output current limit <5.0A

Connector USB Type-C™

Environmental Design Operating temperature 32°F to 95°F (0°to 35°C)

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.



Technical Specifications

HP 45W Smart AC adapter Dimensions 3.74 x 1.57 x 1.04 in (9.5 x 4.0 x 2.65 cm)

> Weight 0.386 lb (175a) max Input 90 to 265 VAC

> > **Input Efficiency** 87.74% at 115Vac and 88.4% at 230Vac

Input frequency range 47 to 63 Hz **Input AC current** 1.4 A at 90 VAC

Output **Output power** 45W

> DC output 19.5V

Hold-up time 5 msec at 115 VAC input

Output current limit <8.0A

Connector 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

Environmental Design 32° to 95° F (0° to 35° C) Operating temperature Non-operating (storage) -4° to 185° F (-20° to 85° C)

temperature

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety CE Mark - full compliance with LVD and EMC directives

Certifications Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

HP 65W Smart AC adapter Dimensions 107.0x47.0x30.0mm

> Weight unit: 250g +/- 10g

Input **Input Efficiency** 88.0 % at 115 Vac and 89.0 % at 230Vac

> 47 ~ 63 Hz Input frequency range

Input AC current Max. 1.7 A at 90 Vac

Output 65W **Output power**

> **DC** output 19.5V

Hold-up time 5ms at 115 Vac input

Output current limit <11.0A

Connector 4.5mm Barrel Type

Environmental Design Operating temperature 32°F to 95°F (0°to 35°C)

Non-operating (storage)

temperature

-4°F to 185°F (-20°to 85°C)

Altitude 0 to 16,400 ft (0 to 5000m)

20% to 95% **Humidity Storage Humidity** 10% to 95%

EMI and Safety CE Mark - full compliance with LVD and EMC directives **Certifications**

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

Dimensions 102x55x30mm

Technical Specifications

HP 65W EM Smart AC adapter

Weight 270g +/- 10g

Input Input Efficiency 87% min at 115V/230V

Input frequency range 47 to 63 Hz

Input AC current 1.7 A at 90 VAC and maximum load

Output Output power

DC output 65W(19.5V/3.33A) **Hold-up time** 5 msec at 115 VAC input

Output current limit <11A, Over voltage protection- 29V max

automatic shutdown

Connector 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

Environmental Design Operating temperature 0° to 35° C

Non-operating (storage) -20° to 85° C

temperature

Altitude 0 to 5,000 m Humidity 0% to 95% Storage Humidity 0% to 95%

EMI and Safety CE Mark - EMC directives; Worldwide safety standards - IEC60950, Certifications EN60950, UL60950, Class 1, SELV: Agency approvals - C-UL-US, NO

EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; Reliability - failure rate of less than 0.1% annually within the first three

years of operation.

HP 65W Watt Smart Travel Adapter
 Dimensions
 120.0x57.6x16.7mm

 Weight
 unit: 250g +/- 10g

Input Input Efficiency 88.0 % at 115 Vac and 89.0 % at 230 Vac

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.7 A at 90 Vac

Output Output power 65W

DC output 19.5V/5V

Hold-up time 5ms at 115 Vac input

Output current limit <11.0A

Connector 4.5mm/7.4mm tips

Environmental Design Operating temperature 32°F to 95°F (0°to 35°C)

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety CE Mark - full compliance with LVD and EMC directives

Certifications Worldwide safety standards - IEC60950, EN60950, UL60950, Class1,

SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. MTBF - over 200,000 hours at 25°C ambient condition.

Dimensions (H x W x L) 8.05. x185.15x95 mm

Technical Specifications

Weight 0.26 kg

Cells/Type 3cell Lithium-Ion Polymer cell / 606072 3cell Lithium-Ion Prismatic cell / 606080

Energy Voltage 11.4V

No

Amp-hour capacity 4.212Ah /4.0Ah

Watt-hour capacity 50Wh

Temperature Operating (Charging) 32° to 113° F (0° to 45° C)

Operating (Discharging) 14° to 122° F (-10° to 60° C)

Fuel Gauge LED N/A

Warranty 3 years⁶

Optional Travel Battery

Available

COUNTRY OF ORIGIN

Battery CD 3 Cell WHr 48

Long Life -PR+PL Fast

Charge

China



Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part #
Cases	HP 15.6 Business Top Load	2SC66AA
	HP Slim Top Load	F3W15AA
	HP Slim Backpack	F3W16AA
Docking	HP 2013 UltraSlim Docking Station	D9Y32AA
	HP USB-C Dock G4	3FF69AA
	HP USB-C Universal Dock	1MK33AA
Input/Output	HP Slim USB Keyboard and Mouse	T6T83AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Ultra Mobile Wireless Mouse	H6F25AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP Wireless Premium Mouse	1JR31AA
	HP Slim Bluetooth Mouse	F3J92AA
	HP USB Premium Mouse	1JR32AA
	HP USB Travel Mouse	G1K28AA
	HP Elite Presenter Mouse	2CE30AA
	HP HDMI to DVI Adapter	F5A28AA
	HP HDMI to VGA	H4F02AA
	HP USB-C to DP	N9K78AA
	HP USB-C to USB-A Hub	Z6A00AA
	HP USB-C to VGA	N9K76AA
	HP Stereo 3.5mm Headset	T1A66AA
	HP Stereo USB Headset	T1A67AA
Power	HP 45W Smart AC Adapter	H6Y88AA
	HP 65W Smart AC Adapter	H6Y89AA
	HP 45W USB-C Power Adapter	1HE07AA
	HP 65W USB-C Power Adapter	1HE08AA
	HP USB-C Notebook Power Bank	2NA10AA
_	up F	
Storage	HP External USB Optical Drive	F2B56AA
	HP 128GB TLC M.2 SATA-3	2JB95AA
	HP 256GB TLC PCIe 3x4 NVMe M.2 SSD	1FU87AA
	HP 512GB TLC PCIe 3x4 NVMe M.2 SSD	1FU88AA
Security	HP Docking Station Cable Lock	AU656AA#XXX
-	HP 14.0" Notebook Privacy Filter	J6E65AA
	HP Keyed Cable Lock 10mm	T1A62AA
	•	

Options and Accessories (sold separately and availability may vary by country)

Memory	HP 4GB DDR4 Memory	Z4Y84AA
-	HP 8GB DDR4 Memory	Z4Y85AA
	HP 16GB DDR4 Memory	Z4Y86AA
UCC	HP Wireless Collaboration Keyboard	Z9N39AA
	HP USB Collaboration Keyboard	Z9N38AA
	HP UC Speaker Phone	K7V16AA
	HP UC Wireless Mono Headset	W3K08AA
	HP UC Wireless Duo Headset	W3K09AA
Displays	HP ProDisplay P223 21.5-inch Monitor	X7R61AA
	HP ProDisplay P240va 23.8-inch Monitor	N3H14AA
	HP EliteDisplay E243 23.8-inch Monitor	1FH47AA



Summary of Changes

Date of change:	Version History:	Updated	Description of change:
March 30, 2018	V1 to V2	Updated	Processors, at a glance section updated
May 23, 2018	V2 to V3	Updated	Docking stations table added
May 29, 2018	V3 to V4	Updated	HDD's removed
June 7, 2018	V4 to V5	Updated	Battery life, Dimensions & Weight updated
September 26, 2018	V5 to v6	Removed	360GB Intel PCle SSD
October 8, 2018	V6 to v7	Added	Compliance in at a glance section
February 13, 2019	V7 to v8	Removed	Phonewise Software
June 12, 2019	V8 to v9	Updated	EPEAT
June 28, 2019	V9 to v10	Updated	Color Gamut
October 9, 2019	V10 to v11	Updated	Ports Section

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